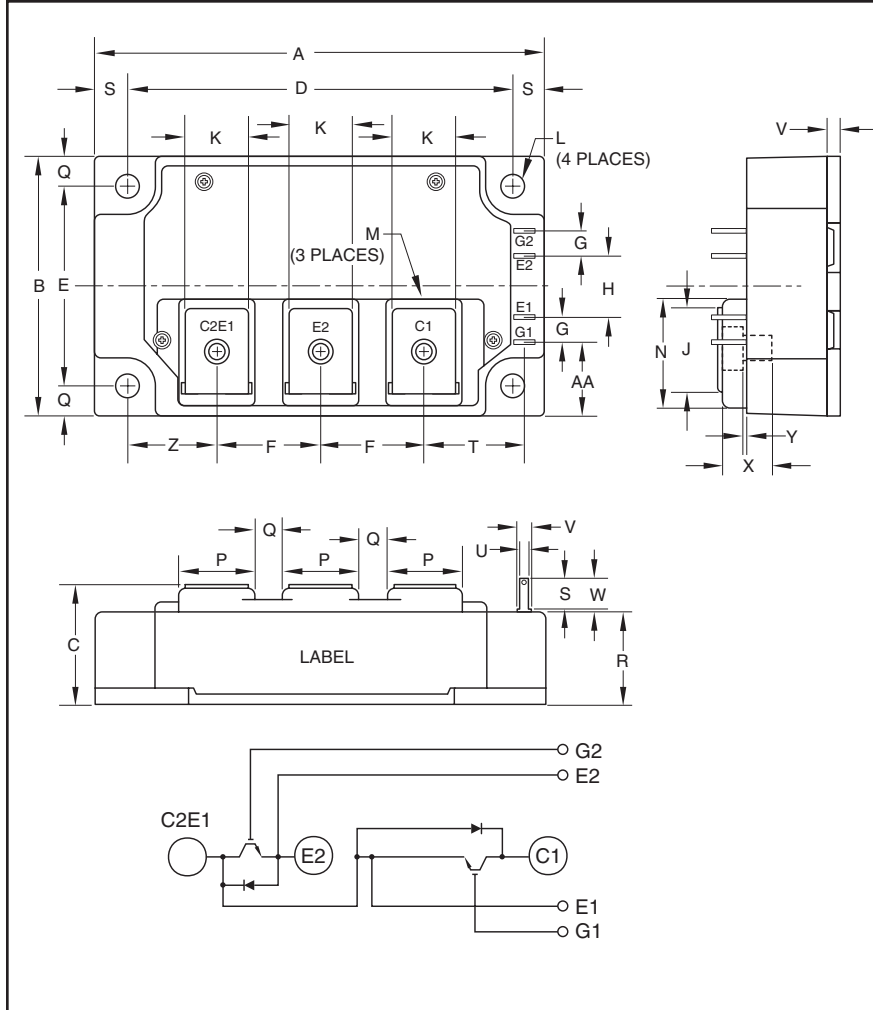


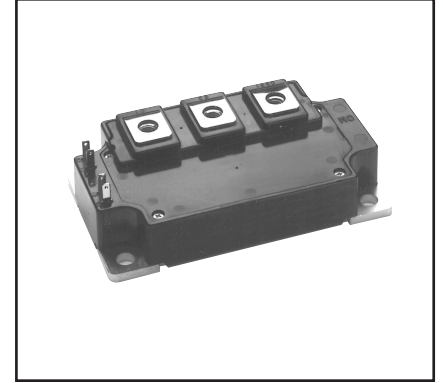
Dual IGBTMOD™ NFH-Series Module 400 Amperes/600 Volts



Outline Drawing and Circuit Diagram

Dimensions	Inches	Millimeters
A	4.25	108.0
B	2.44	62.0
C	1.14+0.04/-0.02	29.0+1.0/-0.5
D	3.66±0.01	93.0±0.25
E	1.89±0.01	48.0±0.25
F	0.98	25.0
G	0.24	6.0
H	0.59	15.0
J	0.7854	19.95
K	0.55	14.0
L	0.26 Dia.	6.5 Dia.
M	M6 Metric	M6
N	1.022	25.95

Dimensions	Inches	Millimeters
P	0.71	18.0
Q	0.28	7.0
R	0.874	22.2
S	0.30	7.5
T	0.94	24.0
U	0.11	2.8
V	0.16	4.0
W	0.33	8.5
X	0.46	11.75
Y	0.012 ~ 0	0.3 ~ 0
Z	0.85	21.5
AA	0.69	17.5



Description:

Powerex IGBTMOD™ Modules are designed for use in high frequency applications; 30 kHz for hard switching applications and 60 to 70 kHz for soft switching applications. Each module consists of two IGBT Transistors in a half-bridge configuration with each transistor having a reverse-connected super-fast recovery free-wheel diode. All components and interconnects are isolated from the heat sinking baseplate, offering simplified system assembly and thermal management.

Features:

- ☐ Low $V_{CE(sat)}$
- ☐ Low $ESW(off)$
- ☐ Discrete Super-Fast Recovery Free-Wheel Diode
- ☐ Isolated Baseplate for Easy Heat Sinking

Applications:

- ☐ Power Supplies
- ☐ Induction Heating
- ☐ Welders

Ordering Information:

Example: Select the complete part module number you desire from the table below -i.e.

CM400DU-12NFH is a 600V (V_{CES}), 400 Ampere Dual IGBTMOD™ Power Module.

Type	Current Rating Amperes	V_{CES} Volts (x 50)
CM	400	12

CM400DU-12NFH

Dual IGBTMOD™ NFH-Series Module

400 Amperes/600 Volts

Absolute Maximum Ratings, $T_j = 25^\circ\text{C}$ unless otherwise specified

Ratings	Symbol	CM400DU-12NF	Units
Junction Temperature	T_j	-40 to 150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-40 to 125	$^\circ\text{C}$
Collector-Emitter Voltage (G-E Short)	V_{CES}	600	Volts
Gate-Emitter Voltage (C-E Short)	V_{GES}	± 20	Volts
Collector Current ($T_C = 25^\circ\text{C}$)	I_C	400*	Amperes
Peak Collector Current	I_{CM}	800*	Amperes
Emitter Current** ($T_C = 25^\circ\text{C}$)	I_E	400*	Amperes
Peak Emitter Current**	I_{EM}	800*	Amperes
Maximum Collector Dissipation ($T_C = 25^\circ\text{C}$, $T_j \leq 150^\circ\text{C}$)	P_C	960	Watts
Maximum Collector Dissipation ($T_C = 25^\circ\text{C}$, $T_j \leq 150^\circ\text{C}$)	P_C	1640	Watts
Mounting Torque, M6 Main Terminal	—	40	in-lb
Mounting Torque, M6 Mounting	—	40	in-lb
Weight	—	400	Grams
Isolation Voltage (Main Terminal to Baseplate, AC 1 min.)	V_{ISO}	2500	Volts

Static Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Collector-Cutoff Current	I_{CES}	$V_{\text{CE}} = V_{\text{CES}}$, $V_{\text{GE}} = 0\text{V}$	—	—	1.0	mA
Gate Leakage Current	I_{GES}	$V_{\text{GE}} = V_{\text{GES}}$, $V_{\text{CE}} = 0\text{V}$	—	—	0.5	μA
Gate-Emitter Threshold Voltage	$V_{\text{GE(th)}}$	$I_C = 40\text{mA}$, $V_{\text{CE}} = 10\text{V}$	5.0	6.0	7.0	Volts
Collector-Emitter Saturation Voltage	$V_{\text{CE(sat)}}$	$I_C = 400\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 25^\circ\text{C}$	—	2.0	2.7	Volts
		$I_C = 400\text{A}$, $V_{\text{GE}} = 15\text{V}$, $T_j = 125^\circ\text{C}$	—	1.95	—	Volts
Total Gate Charge	Q_G	$V_{\text{CC}} = 300\text{V}$, $I_C = 400\text{A}$, $V_{\text{GE}} = 15\text{V}$	—	2480	—	nC
Emitter-Collector Voltage**	V_{EC}	$I_E = 400\text{A}$, $V_{\text{GE}} = 0\text{V}$	—	—	2.6	Volts

Dynamic Electrical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Input Capacitance	C_{ies}	$V_{\text{CE}} = 10\text{V}$, $V_{\text{GE}} = 0\text{V}$	—	—	110	nf
Output Capacitance	C_{oes}		—	—	7.2	nf
Reverse Transfer Capacitance	C_{res}		—	—	4.0	nf
Inductive	Turn-on Delay Time	$V_{\text{CC}} = 300\text{V}$, $I_C = 400\text{A}$, $V_{\text{GE1}} = V_{\text{GE2}} = 15\text{V}$, $R_G = 3.1\Omega$, Inductive Load Switching Operation,	—	—	400	ns
Load	Rise Time		—	—	200	ns
Switch	Turn-off Delay Time		—	—	700	ns
Time	Fall Time		—	—	150	ns
Diode Reverse Recovery Time**	t_{rr}	$I_E = 400\text{A}$	—	—	200	ns
Diode Reverse Recovery Charge**	Q_{rr}		—	7.7	—	μC

* Pulse width and repetition rate should be such that device junction temperature (T_j) does not exceed $T_{j(\text{max})}$ rating.

**Represents characteristics of the anti-parallel, emitter-to-collector free-wheel diode (FWDi).

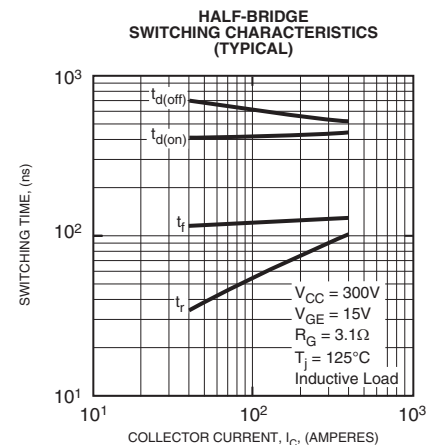
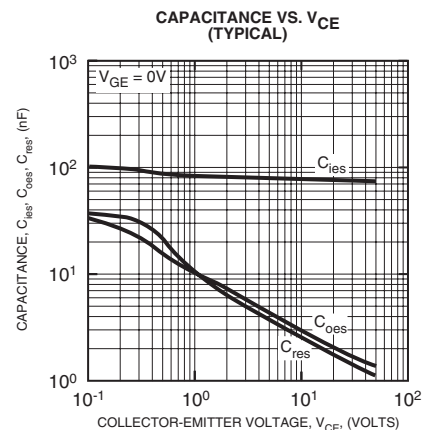
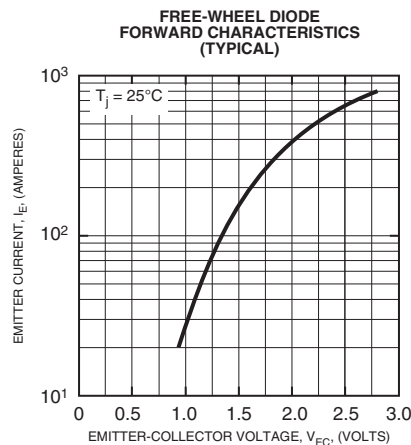
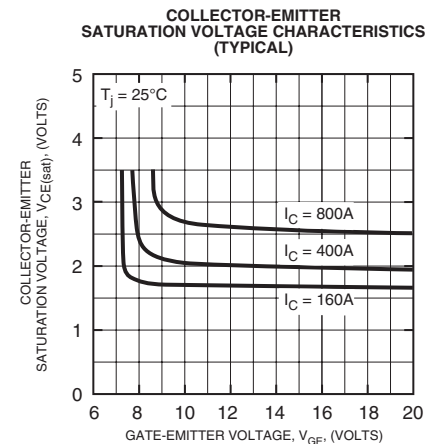
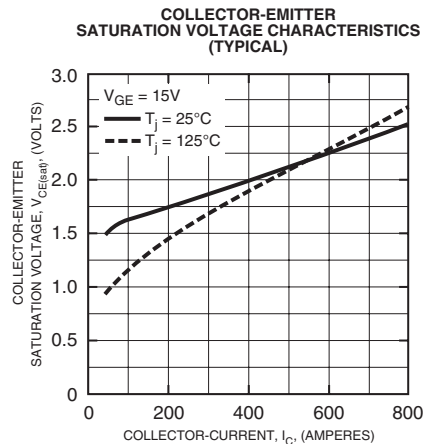
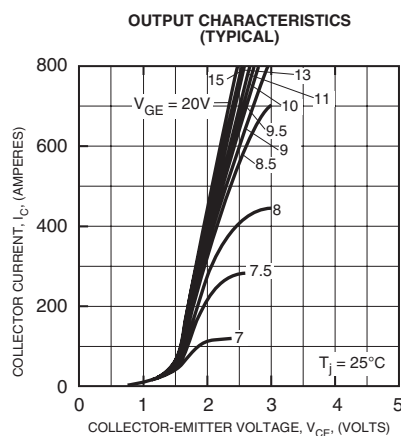
CM400DU-12NFH

Dual IGBTMOD™ NFH-Series Module

400 Amperes/600 Volts

Thermal and Mechanical Characteristics, $T_j = 25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Thermal Resistance, Junction to Case	$R_{th(j-c)Q}$	Per IGBT 1/2 Module, T_C Reference Point per Outline Drawing	—	—	0.13	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)D}$	Per FWDi 1/2 Module, T_C Reference Point per Outline Drawing	—	—	0.18	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{th(j-c)'Q}$	Per IGBT 1/2 Module, T_C Reference Point Under Chips	—	—	0.076	$^\circ\text{C/W}$
Contact Thermal Resistance	$R_{th(c-f)}$	Per 1/2 Module, Thermal Grease Applied	—	0.04	—	$^\circ\text{C/W}$
External Gate Resistance	R_G		1.6	—	16	Ω

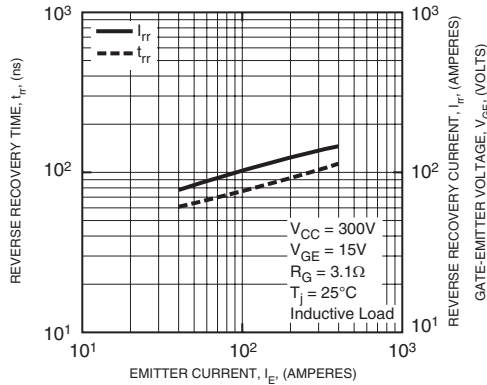


CM400DU-12NFH

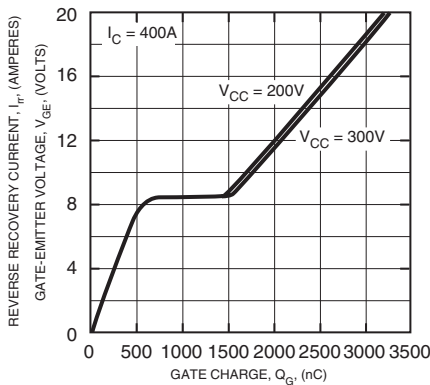
Dual IGBTMOD™ NFH-Series Module

400 Amperes/600 Volts

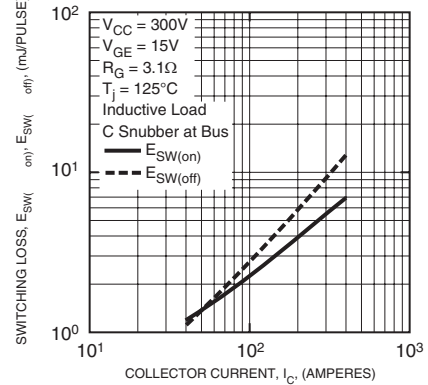
REVERSE RECOVERY CHARACTERISTICS
(TYPICAL)



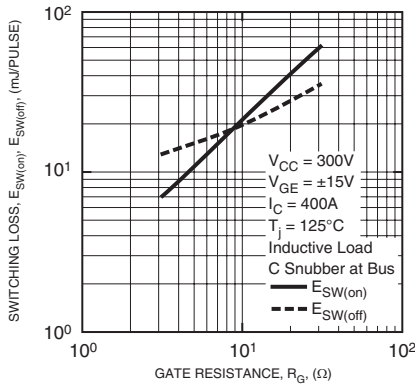
GATE CHARGE VS. V_{GE}



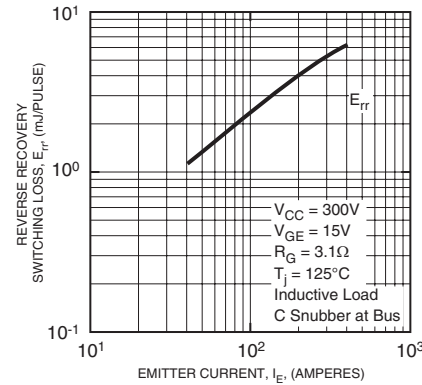
SWITCHING LOSS VS. COLLECTOR CURRENT
(TYPICAL)



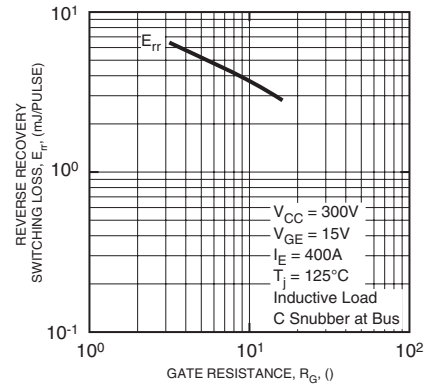
SWITCHING LOSS VS. GATE RESISTANCE
(TYPICAL)



REVERSE RECOVERY SWITCHING LOSS VS. EMITTER CURRENT
(TYPICAL)



REVERSE RECOVERY SWITCHING LOSS VS. GATE RESISTANCE
(TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS
(IGBT & FWDI)

